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MASAYUKI HATTORI (11/21/2007)	
	Name: SONY CORPORATION
	Name: SON Y CORPORATION Internal Address:
Execution Date(s): In parentheses after inventor name	Street Address:
Additional name(s) of conveying party(ies) attached? Yes X No	1-7-1 Konan, Minato-ku
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4,	This document is being filed together with a new application.  B. Patent No.(s)
A. Patent Application No.(s) 11/900,636	B. Fateric (NO.(4)
1110001000	
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Additional numbers attached?	<del></del>
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Dennis M. Smid, Esq.	
LERNER, DAVID, LITTENBERG,	40.00
KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$
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Fax Number: (908) 654-0415	b. Deposit Account Number 12-1095
Email Address:dsmid@ldlkm.com	Authorized User Name Dennis M. Smid, Esq.
9. Signature:	
25 NJ	December 4, 2007
Signature	Date
Dennis M. Smid, Esq 34,930	Total number of pages including cover sheet, attachments, and documents: 3
Name of Person Signing	attand district and accounts

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Docket No.: SONYJP 3.0-1473 Sony Ref. No.: S07P1290US00

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

## OFDM RECEIVER AND OFDM SIGNAL RECEIVING METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, my entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 11/900,636; Filing Date: September 11, 2007.

This assignment executed on the dates indicated below.

Hidetoshi Kawauchi Name of First or Sole Inventor	Execution Date of U.S. Patent Application
Residence of First or Sole Inventor  Hid Toshi Lawandai  Signature of First or Sole Inventor	Nov. 21, 2007  Date of this Assignment

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Docket No.: SONYJP 3.0-1473 Sony Ref. No.: S07P1290US00

Masayuki Hattori Execution Date of U.S. Patent Application Name of Second Joint Inventor Kanagawa, Japan Residence of Second Joint Inventor Execution Date of U.S. Patent Application Name of Third Joint Inventor Residence of Third Joint Inventor Signature of Third Joint Inventor Date of this Assignment Execution Date of U.S. Patent Application Name of Fourth Joint Inventor Residence of Fourth Joint Inventor Signature of Fourth Joint Inventor Date of this Assignment Execution Date of U.S. Patent Application Name of Fifth Joint Inventor Residence of Fifth Joint Inventor Date of this Assignment Signature of Fifth Joint Inventor

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**RECORDED: 12/04/2007** 

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